

The Big Deal

- Patented design eliminates in band spurs
- Pass band cut-off up to 21 GHz
- Stop band up to 35 GHz
- Excellent repeatability through IPD* process



Available in Low Pass, High Pass and Band Pass designs

Product Overview

Mini-Circuits' *X-Series* reflectionless filters employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level which interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features	Advantages
Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stop band; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect pass band signals.
Excellent power handling in a tiny surface mount device	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.
Small size, 3x3mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, sav- ing board space.
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.
Excellent stability over temperature	With ± 0.3 dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.
Operating temperature up to 105°C	Suitable for operation close to high power components.

*IPD - Integrated Passive Device, is a GaAs semiconductor process

Reflectionless Low Pass Filter

50Ω DC to 1150 MHz

Features

- \bullet Match to 50 Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent Power handling
- Temperature stable, up to 105°C
- Small size, 3 x 3 mm
- Protected by US Patent No. 8,392,495

Applications

- Harmonics Rejection
- Wideband Matching
- Transmitters / Receivers

General Description





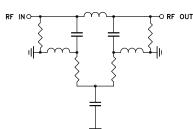
Generic photo used for illustration purposes only CASE STYLE: DQ1225

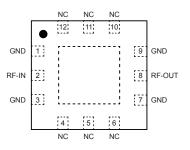
+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost					
Reel Size	Devices/Reel				
7"	20, 50, 100, 200, 500, 1000, 2000				

Mini-Circuits' XLF-122+ reflectionless filter employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

simplified schematic and pad description





Function	Pad Number	Description
RF-IN	2	RF Input Pad
RF-OUT	8	RF Output Pad
GND	1,3,7,9, Paddle	Connected to ground
NC (GND Externally)	4,5,6,10,11,12	No internal connection

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Electrical Specifications¹ at 25°C

Pa	rameter	F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
	Insertion Loss	DC - F1	DC-1150	_	1.4	1.8	dB
Pass Band	Frequency Cut-off	F2	1510	—	3.0	—	dB
	VSWR	DC - F1	DC-1150	—	1.2	_	:1
		F3 - F4	2190 - 10000	11	14	_	dB
	Rejection	F4 - F5	10000 - 21000	—	21	—	dB
Stop Band							:1
	VSWR	F3 - F4	2190 - 10000	—	1.2	—	
		F4 - F5	10000 - 21000	—	1.5	—	:1

¹ Measured on Mini-Circuits Characterization Test Board TB-844-122+

Absolute Maximum Ratings⁴

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (DC-F1) ²	2W at 25°C
RF Power Input, Stopband (F2-F5) ³	0.5W at 25°C

 $^{\scriptscriptstyle 2}$ Passband rating derates linearly to 1W at 105°C ambient

Stopband rating derates linearly to 0.25W at 105°C ambient
 Permanent damage may occur if any of these limits are exceeded.

ESD rating

Human body model (HBM): Class 1A (250 to <500V) in accordance with ANSI/ESD 5.1-2001

MSL rating

Moisture Sensitivity: MSL1 in accordance with IPC/JEDEC J-STD-020D

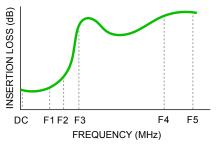
Frequency (MHz) Insertion Loss VSWR (dB) (:1) 10 0.62 1.03 50 100 0.59 1.03 1.04 0.59 200 0.61 1.08 400 1150 1510 0.67 1.16 1.38 2.99 1.32 1.19 2190 15.37 1.24 3000 4000 1.17 1.09 17.56 14.44 5500 15.04 1.06 7000 16.31 1.12 8500 10000 1.12 1.34 16.84 14.72 11500 12.15 1.73 13000 21.84 1.13 24.87 15000 1.30 17000 23.97 1.15 19000 22.90 1.42 21000 23.14 2.59 XLF-122+ INSERTION LOSS XLF-122+ VSWR 30 3.0 INSERTION LOSS (dB) 2.5 20 VSWR 2.0 10 1.5 0 1.0 4200 8400 12600 21000 0 4200 8400 12600 16800 21000 0 16800 FREQUENCY (MHz) FREQUENCY (MHz)

Typical Performance Data at 25°C

lMini-Circuits

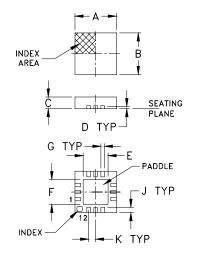
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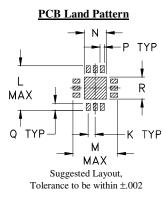
Specification Definition



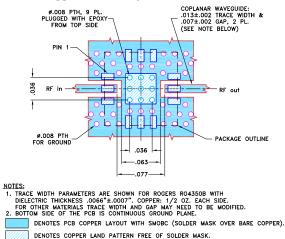
XLF-122+

Outline Drawing





Demo Board MCL P/N: TB-844-122+ (without connectors) TB-844-122C+ (with connectors) B20-118-F1+ Connector sold separately Suggested PCB Layout: PL-451+



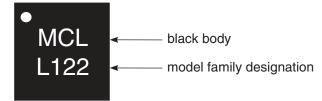
Outline Dimensions (inch)

J	н	G	F	E	D	С	В	А
.016		.009	.057	.057	.008	.035	.118	.118
0.41		0.23	1.45	1.45	0.20	0.89	3.00	3.00
wt		R	Q	Р	Ν	М	L	К
grams		.049	.020	.010	.049	.127	.127	.020
0.02		1.24	0.51	0.25	1.24	3.23	3.23	0.51

Tape & Reel Packaging

DEVICE ORIENTATION IN T&R

Product Marking



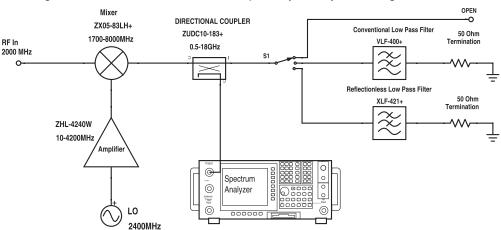
DIRECTION	OF	FEED
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Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
8	4	7	Small quantity standard	20 50 100 200 500
		7	Standard	1000, 2000



Application Circuit Example

Pairing mixers with reflectionless filters to improve system dynamic range



Test block diagram: IF output reflection spectrum with single input frequency

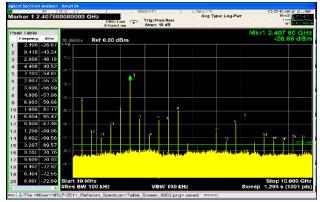


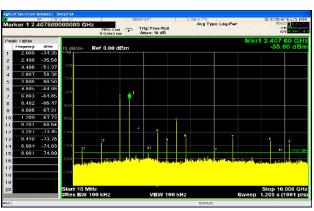
Figure 1. IF output reflection spectrum without filter

An application circuit was assembled to measure the IF reflection spectrum at the output of a mixer when the mixer was paired with a conventional filter versus a reflectionless filter.

While the conventional filter reduces the reflections present when the mixer is used alone (no filter), the reflectionless filter virtually eliminates those reflections altogether.

The reflected signal at marker 1 in the figures above exhibits a reduction of more than 20 dB from -28.7 dBm to -50.3 dBm when the reflectionless filter is used as compared to the conventional filter, thus eliminating unwanted spurious mixing products and improving-system dynamic range.

For more information, refer to application note AN-75-007





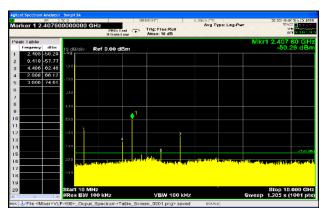


Figure 3. IF output reflection spectrum with reflectionless filter

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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